

TRANSMITTAL

Electronic Version v1.1

Stylesheet Version v1.1.0

Title of Invention	[METHOD OF FABRICATING SHALLOW TRENCH ISOLATION STRUCTURE FOR REDUCING WAFER SCRATCH]							
Application Number :								
Date :								
First Named Applicant:	Mr. Jason Lu							
Confirmation Number:								
Attorney Docket Number:	13155-US-PA							
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<table border="1"><tr><td>Submitted By:</td><td>Elec. Sign.</td><td>Sign. Capacity</td></tr><tr><td>Dr. Belinda Lee Registered Number: 46863</td><td>/Belinda Lee/</td><td>Agent</td></tr></table>			Submitted By:	Elec. Sign.	Sign. Capacity	Dr. Belinda Lee Registered Number: 46863	/Belinda Lee/	Agent
Submitted By:	Elec. Sign.	Sign. Capacity						
Dr. Belinda Lee Registered Number: 46863	/Belinda Lee/	Agent						

Documents being submitted:	Files
us-assignment	13155-usassn.xml us-assignment.xsl us-assignment.dtd 13155assignment01.tif 13155assignment02.tif
us-request	13155-usrequ.xml us-request.dtd us-request.xsl
us-fee-sheet	13155-usfees.xml us-fee-sheet.xsl us-fee-sheet.dtd
us-declaration	13155declaration01.tif
application-body	13155-trans.xml us-application-body.xsl application-body.dtd wipo.ent mathml2.dtd mathml2-qname-1.mod isoamsa.ent isoamsb.ent isoamsc.ent isoamsn.ent isoamso.ent isoamsr.ent isogr3.ent isomfrk.ent isomopf.ent isomscr.ent isotech.ent isobox.ent isocyr1.ent isocyr2.ent isodia.ent isolat1.ent isolat2.ent isonum.ent isopub.ent mmlextra.ent mmlalias.ent soextblx.dtd 13155US0001.tif 13155US0002.tif 13155US0003.tif 13155US0004.tif 13155US0005.tif 13155US0006.tif
us-declaration	13155declaration02.tif
Comments	
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